I hereby appoint the following attorney(s) and/or agent(s) to prosecute the application entitled <u>COOLING OF MOLDS</u> and to transact all business in the Patent and Trademark Office connected therewith:

J. HAROLD NISSEN, Reg. No. 17,283; HENRY A. MARZULLO, JR., Reg. No. 20,910; MYRON GREENSPAN, Reg. No. 25,680; MARVIN FELDMAN, Reg. No. 25,797; HOWARD N. ARONSON, Reg. No. 27,302; and THOMAS BLANKINSHIP, Reg. No. 39,909.

Address all telephone calls to *J. Harold Nissen*, at telephone number (914) 723-4300, or to the attorney executing the last document; address all correspondence to LACKENBACH SIEGEL at One Chase Road, Scarsdale, New York 10583 U.S.A.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of First or Sole Inventor Malcolm Barry JAMES	Citizenship Australian
RESIDENCE Address - Street 2 Janet St.	POST OFFICE Address - Street
city (Zip) Campbelltown	City (Zip)
State or Country South Australia, Australia	State or Country
Date 77H APRIL 2002	Signature Ame
Full Name of Second Joint Inventor	Citizenship U.S.
RESIDENCE Address - Street	POST OFFICE Address Street
City (Zip)	City (Zip)
State or Country	State or Country
Date	Signature
<del></del>	

<sup>☐</sup> Additional inventors are being named on separately numbered sheets attached hereto.

## UNITED STATES -- PATE TO DECLARATION FOR PATE APPLICATION

Acney's Docket No.: P-33/Colli.

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a design patent is sought on the invention entitled <u>COOLING OF MOLDS</u>, the specification of which

□ Is attached hereto.
☑ Was filed on March 22, 2002 as United States Application number or PCT Int'l Application
No. PCT/AU00/01160 and was amended on (if applicable)
and a pre-examination amendment was filed with the application.  Application Serial No.: 10/089171
and was amended on (if applicable)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

**Prior Foreign Application(s):** 

Application Number	Country	Date Filed	Priority Claimed
PCT/AU00/01160	Australia	25 September 2000	⊠ YES □ NO
PQ3077	Australia	24 September 1999	⊠ YES □ NO
PQ3334	Australia	11 October 1999	⊠ YES □ NO

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56(a) which became available between the filing date of the prior application and the national or PCT international filing date of this application:

Application Serial No.	lication Serial No. Filing Date Status: Patented, Pending, Aband	
		☐ Patented ☐ Pending ☐ Abandoned
		☐ Patented ☐ Pending ☐ Abandoned
		☐ Patented ☐ Pending ☐ Abandoned